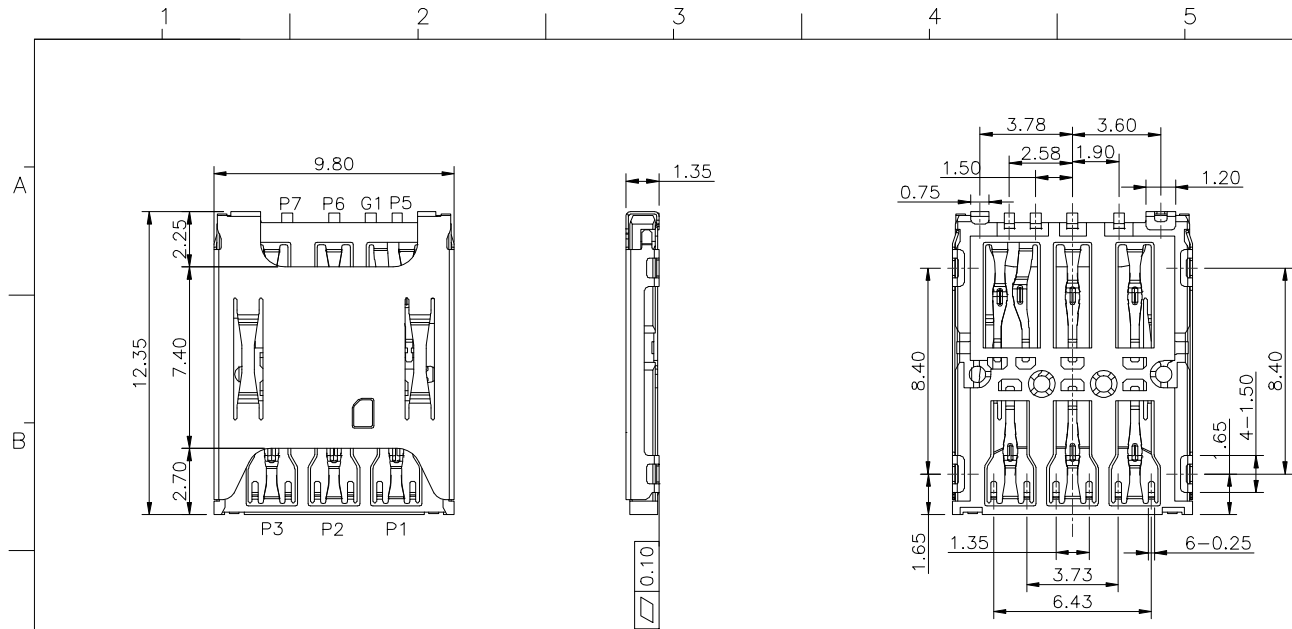


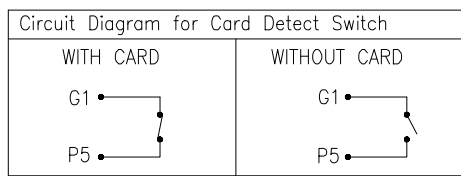
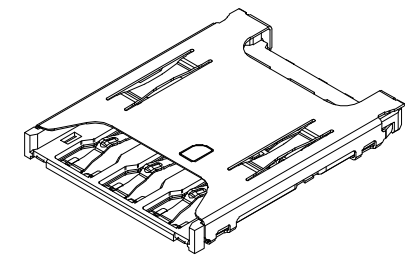
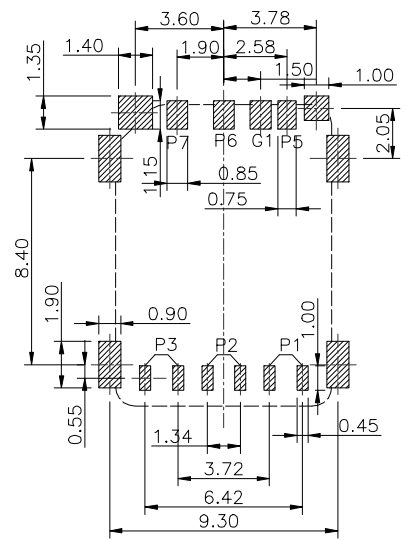
REV	LOCAS	DESCRIPTION	DRAW	DATE
01	NEW	PERLIMINARY	Andy	2017.07.25



- NOTES:
- MATERIAL:
 - Housing: High Temperature Thermoplastic UL94V-0; Color Black.
 - Terminal: Copper Alloy, T=0.08mm;
 - Shell: Stainless Steel, T=0.10mm;
 - FINISH:
 - Terminal: Plated Gold on the Contact Area and Solder Tails, Underplated Nickel Over all.
 - Shell: Plated Gold on the Solder Tails, Underplated Nickel Over all.
 - SPECIALITY:
 - Rated current: 1.0A
 - Rated voltage: 30V
 - Contact Resistance: 50mΩ MAX
 - Insulation Resistance: 100MΩ MIN 100V DC
 - Dielectric withstanding voltage: 250V AC.
 - Solder ability: 245±5°C, 5±0.5s.
 - Durability: 5000 Cycles Min.
 - Operating Temperature: -25°C ~ +85°C;



SIM CARD PIN NO.	PIN NO.
P1	VCC
P2	RST
P3	CLK
P5	GND
P6	VPP
P7	I/O
G1	SWITCH PIN



RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

MEASURE POINT: QUADRANT POINT (QP) TANGENCY POINT (TP) INTERSECTION POINT (IP)	 DONG GUAN D-CHAIN TECHNOLOGY CO.,LTD		DESIGN	Andy	DATE	2017.07.25	TITLE:	1.35H NANO SIM CARD 7PIN	
UNLESS OTHERWISE SPECIFIED, TOLERANCE: X. ±0.25 X.x ±0.20 X.xx ±0.10 ANGULAR ±3'			CHECKED		DATE		APPROVED	DATE	REV: 01
PART No. SA0601254135-133			DRAWING No.		SIZE: A4	SHEET: 1/1			